

ISO 1043

ISO 11469

ISO 179/1eA

ISO 180/1A

ISO 180/1A

ISO 180/1U

ISO 180/1U

## Zytel® HTN51G35HSL BK083

### HIGH PERFORMANCE POLYAMIDE RESIN

Zytel® HTN high performance polyamide resins feature high retention of properties upon exposure to elevated temperature, to high moisture, and to harsh chemical environments. Polymer families and grades of Zytel® HTN are tailored to optimize performance as well as processability.

Typical applications with Zytel® HTN include demanding applications in the automotive, electrical and electronics, domestic appliances, and construction industries.

Zytel® HTN51G35HSL BK083 is a 35% glass reinforced, heat stabilized, lubricated, hydrolysis resistant high performance polyamide resin. It is also a PPA resin.

#### Product information

Charpy notched impact strength, -40°C

Izod notched impact strength, 23°C

Izod notched impact strength, -30°C

Izod impact strength, 23°C

Izod impact strength, -30°C

Poisson's ratio

Resin Identification

Part Marking Code

Part Marking Code	>PPA-GF35<		SAE J1344
ISO designation	ISO 16396-PA6T/	XT,GF35,M1CGHR,S1C	)-120
Rheological properties	dry/cond.		
Viscosity number	100/*	cm³/g	ISO 307, 1157, 1628
Moulding shrinkage, parallel	0.2/-	%	ISO 294-4, 2577
Moulding shrinkage, normal	0.6/-	%	ISO 294-4, 2577
Typical mechanical properties	dry/cond.		
Tensile Modulus	12000/11500	MPa	ISO 527-1/-2
Stress at break	210/210	MPa	ISO 527-1/-2
Strain at break	2.4/2.3	%	ISO 527-1/-2
Flexural Modulus	12600/-	MPa	ISO 178
Flexural Strength	323/-	MPa	ISO 178
Charpy impact strength, 23°C	70/-	kJ/m²	ISO 179/1eU
Charpy impact strength, -30°C	70/40	kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C	10/-	kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C	10/9	kJ/m²	ISO 179/1eA

PA6T/XT-GF35

>PA6T/XT-GF35<

9/-

10/-

8/-

65/-

67/-

0.33/0.33

kl/m<sup>2</sup>

kJ/m²

kJ/m<sup>2</sup>

kI/m<sup>2</sup>

kJ/m<sup>2</sup>

Revised: 2021-04-06 Page: 1 of 11



### HIGH PERFORMANCE POLYAMIDE RESIN

Thermal properties	dry/cond.		
Melting temperature, first heat	300/*	°C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	135/95	°C	ISO 11357-1/-2
Temp. of deflection under load, 1.8 MPa	264/*	°C	ISO 75-1/-2
Temp. of deflection under load, 0.45 MPa	284/*	°C	ISO 75-1/-2
CLTE, Parallel, -40-23°C	18/*	E-6/K	ISO 11359-1/-2
Coeff. of linear therm. expansion, parallel	19/*	E-6/K	ISO 11359-1/-2
CLTE, Parallel, 55-160°C	18/*	E-6/K	ISO 11359-1/-2
CLTE, Normal, -40-23°C	51/*	E-6/K	ISO 11359-1/-2
Coeff. of linear therm. expansion, normal	60/*	E-6/K	ISO 11359-1/-2
Coeff. of linear therm. expansion, Normal, 55-160°C	75/*	E-6/K	ISO 11359-1/-2
RTI, electrical, 0.75mm	150	°C	UL 746B
RTI, electrical, 1.5mm	150	°C	UL 746B
RTI, electrical, 3mm	150	°C	UL 746B
RTI, impact, 0.75mm	125	°C	UL 746B
RTI, impact, 1.5mm	125	°C	UL 746B
RTI, impact, 3mm	130	°C	UL 746B
RTI, strength, 0.75mm	130	°C	UL 746B
RTI, strength, 1.5mm	140/*	°C	UL 746B
RTI, strength, 3mm	150	°C	UL 746B
Flammability	dry/cond.		
Burning Behav. at 1.5mm nom. thickn.	HB/*	class	IEC 60695-11-10
Thickness tested	1.5/*	mm	IEC 60695-11-10
UL recognition	yes/*	-	UL 94
Burning Behav. at thickness h	HB/*	class	IEC 60695-11-10
Thickness tested	0.85/*	mm	IEC 60695-11-10
UL recognition	yes/*	-	UL 94
Oxygen index	26/*	%	ISO 4589-1/-2
Glow Wire Flammability Index, 1.5mm	750/-	°C	IEC 60695-2-12
Glow Wire Flammability Index, 3mm	960/-	°C	IEC 60695-2-12
Glow Wire Ignition Temperature, 1.5mm	775/-	°C	IEC 60695-2-13
Glow Wire Ignition Temperature, 3mm	800/-	°C	IEC 60695-2-13
FMVSS Class	В	-	ISO 3795 (FMVSS 302)
Burning rate, Thickness 1 mm	21	mm/min	ISO 3795 (FMVSS 302)
Electrical properties	dry/cond.		
Relative permittivity, 100Hz	4/-	_	IEC 62631-2-1
Relative permittivity, 100112	3.8/-	-	IEC 62631-2-1
Dissipation factor, 100Hz	90/-	E-4	IEC 62631-2-1
Dissipation factor, 1MHz	170/-	E-4	IEC 62631-2-1
Volume resistivity	>1E13/-	Ohm.m	IEC 62631-3-1
Comparative tracking index	600/-	-	IEC 60112
	200,		.23 00112

Revised: 2021-04-06 Page: 2 of 11



### HIGH PERFORMANCE POLYAMIDE RESIN

Other properties	dry/cond.
------------------	-----------

Humidity absorption, 2mm	1.4/*	%	Sim. to ISO 62
Water absorption, 2mm	4/*	%	Sim. to ISO 62
Density	1470/-	kg/m³	ISO 1183

### **VDA Properties**

Odour	4 class	VDA 270
-------	---------	---------

### Injection

Drying Recommended	yes
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	6-8 h
Processing Moisture Content	≤0.1 %
Melt Temperature Optimum	325 °C
Min. melt temperature	320 °C
Max. melt temperature	330 °C
Mold Temperature Optimum	150 °C
Min. mould temperature	140 <sup>1</sup> °C
Max. mould temperature	180 °C

<sup>1:</sup> Higher temperature needed for thinner sections.

#### Additional Information

Injection molding

During molding, use proper protective equipment and adequate ventilation. Avoid exposure to fumes and limit the hold up time and temperature of the resin in the machine. Purge degraded resin carefully with HDPE.

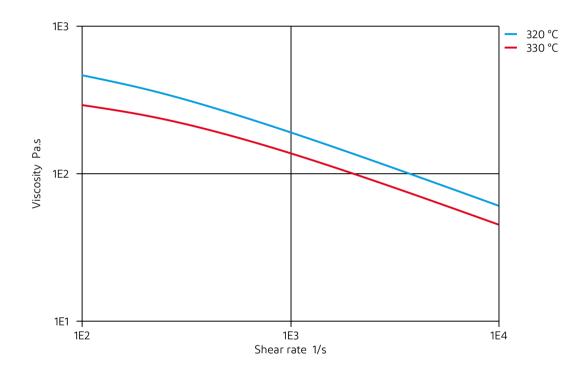
When lower mold temperatures are used, the initial warpage and shrinkage may be lower, but the surface appearance and chemical resistance may be reduced, and the dimensional change may be greater when parts are subsequently heated.

Revised: 2021-04-06 Page: 3 of 11



### HIGH PERFORMANCE POLYAMIDE RESIN

Viscosity-shear rate (measured on Zytel® HTN51G35HSL NC010)

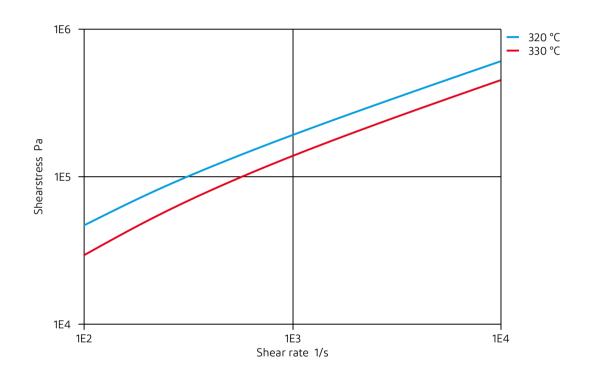


Revised: 2021-04-06 Page: 4 of 11



### HIGH PERFORMANCE POLYAMIDE RESIN

Shearstress-shear rate (measured on Zytel® HTN51G35HSL NC010)

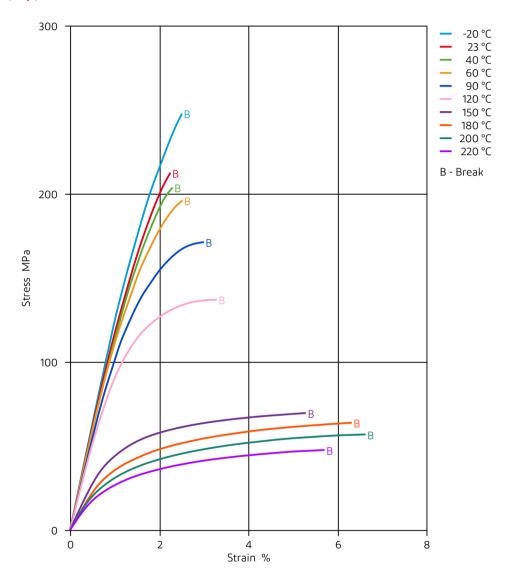


Revised: 2021-04-06 Page: 5 of 11



### HIGH PERFORMANCE POLYAMIDE RESIN

Stress-strain (dry)

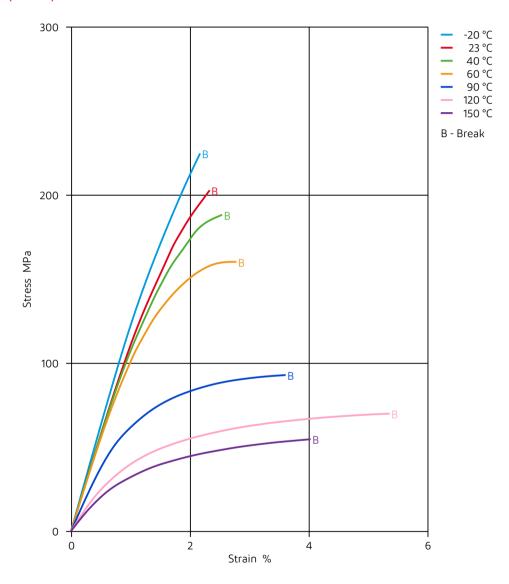


Revised: 2021-04-06 Page: 6 of 11



### HIGH PERFORMANCE POLYAMIDE RESIN

Stress-strain (cond.)

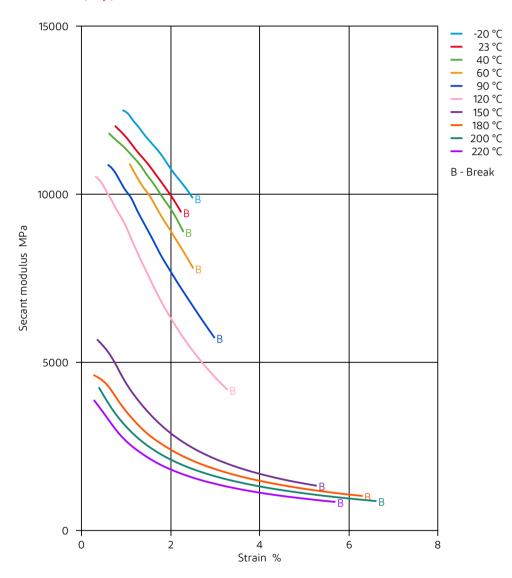


Revised: 2021-04-06 Page: 7 of 11



## HIGH PERFORMANCE POLYAMIDE RESIN

Secant modulus-strain (dry)

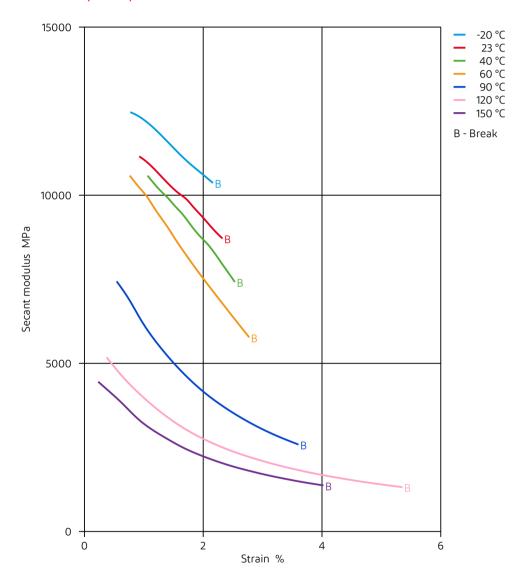


Revised: 2021-04-06 Page: 8 of 11



## HIGH PERFORMANCE POLYAMIDE RESIN

Secant modulus-strain (cond.)

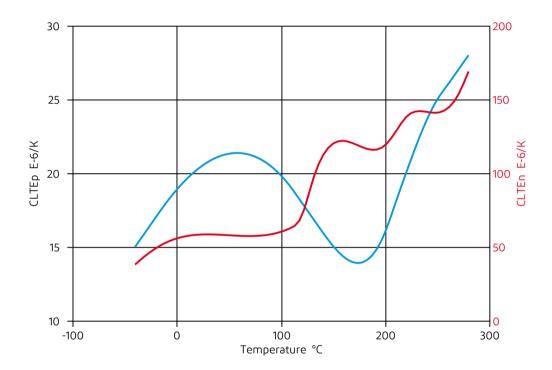


Revised: 2021-04-06 Page: 9 of 11



### HIGH PERFORMANCE POLYAMIDE RESIN

Coeff. of linear thermal expansion



Revised: 2021-04-06 Page: 10 of 11



### HIGH PERFORMANCE POLYAMIDE RESIN

#### Chemical Media Resistance

#### Acids

- ✓ Acetic Acid (5% by mass), 23°C
- ✓ Citric Acid solution (10% by mass), 23°C
- ✓ Lactic Acid (10% by mass), 23°C

#### Other

- ✓ Ethylene Glycol (50% by mass) in water, 108°C
- ✓ Water, 23°C
- ✓ Water, 90°C
- ✓ Coolant Glysantin G48, 1:1 in water, 125°C

#### Symbols used:

✓ possibly resistant

Defined as: Supplier has sufficient indication that contact with chemical can be potentially accepted under the intended use conditions and expected service life. Criteria for assessment have to be indicated (e.g. surface aspect, volume change, property change).

not recommended - see explanation

Defined as: Not recommended for general use. However, short-term exposure under certain restricted conditions could be acceptable (e.g. fast cleaning with thorough rinsing, spills, wiping, vapor exposure).

Revised: 2021-04-06 Page: 11 of 11

The information set forth herein is furnished free of charge, is based on technical data that DuPont believes to be reliable, and represents typical values that fall within the normal range of properties. This information relates only to the specific material designated and may not be valid for such material used in combination with other materials or in other processes. It is intended for use by persons having technical skill, at their own discretion and risk. This information should not be used to establish specification limits nor used alone as the basis of design. Handling precaution information is given with the understanding that those using it will satisfy themselves that their particular conditions of use present no health or safety hazards and comply with applicable law. Since conditions of product use and disposal are outside our control, we make no warranties, express or implied, and assume no liability in connection with any use of this information. As with any product, evaluation under end-use conditions prior to specification is essential. Nothing herein is to be taken as a license to operate or a recommendation to infringe on patents.

CAUTION: Do not use DuPont materials in medical applications involving implantation in the human body or contact with internal body fluids or tissues unless the material has been provided from DuPont under a written contract or other acknowledgement that is consistent with the DuPont policy regarding medical applications and expressly acknowledges the contemplated use. For further information, please contact your DuPont representative.

DuPont's sole warranty is that our products will meet our standard sales specifications in effect at the time of shipment. Your exclusive remedy for breach of such warranty is limited to refund of purchase price or replacement of any product shown to be other than as warranted. TO THE FULLEST EXTENT PERMITTED BY APPLICABLE LAW, DUPONT SPECIFICALLY DISCLAIMS ANY OTHER EXPRESS OR IMPLIED WARRANTY OF FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR NON-INFRINGEMENT. DUPONT DISCLAIMS LIABILITY FOR ANY SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

DuPont™, the DuPont Oval Logo, and all trademarks and service marks denoted with ™, SM or ® are owned by affiliates of DuPont de Nemours, Inc. unless otherwise noted. © 2021 DuPont. All rights reserved.